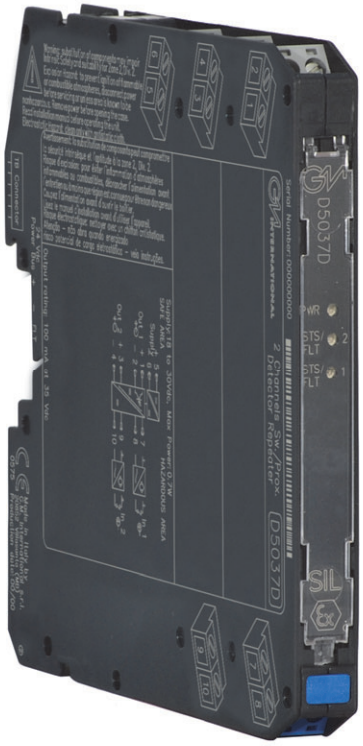


INSTRUCTION & SAFETY MANUAL

SIL 2 Switch/Proximity Detector Repeater Transistor Out, DIN-Rail and Termination Board, Models D5037S, D5037D

gmi technology for safety

Characteristics

General Description: The single and dual channel Switch/Proximity Detector Repeater, D5037S and D5037D module is a unit suitable for applications requiring SIL 2 level (according to IEC 61508:2010 Ed. 2) in safety related systems for high risk industries.
The unit can be configured for switch or proximity detector (EN60947-5-6, NAMUR), NO or NC and for NO or NC optocoupled open collector transistor output.
Each channel enables a Safe Area load to be controlled by a switch, or a proximity detector, located in Hazardous Area.
A fault detection circuit (DIP switch enabled) is available for both proximity sensor and switch equipped with end of line resistors. In case of fault, when enabled, it de-energizes the corresponding output transistor and turns the fault LED on; when disabled the corresponding output transistor repeats the input line open or closed status as configured.
Mounting on standard DIN-Rail, with or without Power Bus, or on customized Termination Boards, in Safe Area or in Zone 2.

Functional Safety Management Certification:
G.M. International is certified by TUV to conform to IEC61508:2010 part 1 clauses 5-6 for safety related systems up to and included SIL3.

Technical Data

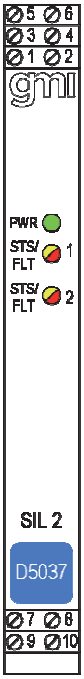
Supply: 24 Vdc nom (18 to 30 Vdc) reverse polarity protected, ripple within voltage limits ≤ 5 Vpp, 2 A time lag fuse internally protected.
Current consumption @ 24 V: 22 mA for 2 channels D5037D, 12 mA for 1 channel D5037S with short circuit input and transistor closed, typical.
Power dissipation: 0.53 W for 2 channels D5037D, 0.30 W for 1 channel D5037S with 24 V supply voltage, short circuit input and transistor closed, typical.
Isolation (Test Voltage): I.S. In/Out 1.5 kV; I.S. In/Supply 1.5 kV; I.S. In/ I.S In 500 V; Out/Supply 500 V; Out/Out 500 V.
Input switching current levels: ON ≥ 2.1 mA (1.9 to 6.2 mA range), OFF ≤ 1.2 mA (0.4 to 1.3 mA range), switch current ≈ 1.65 mA ± 0.2 mA hysteresis.
Fault current levels: open fault ≤ 0.2 mA, short fault ≥ 6.8 mA.
Input equivalent source: 8 V 1 kΩ typical (8 V no load, 8 mA short circuit).
Output: voltage free SPST optocoupled open-collector transistor.
Open-collector rating: 100 mA at 35 Vdc (≤ 1.5 V voltage drop).
Leakage current: ≤ 50 µA at 35 Vdc.
Response time: ≤ 100 µs.
Frequency response: 5 kHz maximum.
Compatibility:
CE mark compliant, conforms to Directive: 2014/34/EU ATEX, 2014/30/EU EMC, 2014/35/EU LVD, 2011/65/EU RoHS.
Environmental conditions:
Operating: temperature limits – 40 to + 70 °C, relative humidity 95 %, up to 55 °C.
Storage: temperature limits – 45 to + 80 °C.
Safety Description:
ATEX: II 3(1)G Ex nA [ia Ga] IIC T4 Gc, II (1)D [Ex ia Da] IIIC, I (M1) [Ex ia Ma] I
IECEx: Ex nA [ia Ga] IIC T4 Gc, [Ex ia Da] IIIC, [Ex ia Ma] I
UL: NI / I / 2 / ABCD / T4, AIS / I, II, III / 1 / ABCDEFG, AEx nA [ia Ga] IIC T4 Gc
C-UL: NI / I / 2 / ABCD / T4, AIS / I, II, III / 1 / ABCDEFG, Ex nA [ia Ga] IIC T4 Gc
EAC-EX: 2Ex nA [ia Ga] IIC T4 Gc X, [Ex ia Da] IIIC X, [Ex ia Ma] I X
UKR TR n. 898: 2ExnAiaIICT4 X, Exial X
associated apparatus and non-sparking electrical equipment.
Uo/Voc = 10.5 V, Io/Isc = 22 mA, Po/Po = 56 mW at terminals 7-8, 9-10.
Um = 250 Vrms, -40 °C ≤ Ta ≤ 70 °C.
Approvals:
BVS 10 ATEX E 113 X conforms to EN60079-0, EN60079-11, EN60079-15,
IECEx BVS 10.0072X conforms to IEC60079-0, IEC60079-11, IEC60079-15,
UL & C-UL E222308 conforms to UL913, UL 60079-0, UL60079-11, UL60079-15,
ANSI/ISA 12.12.01 for UL and CSA-C22.2 No.157-92, CSA-E60079-0, CSA-E60079-11, CSA-C22.2 No. 213 and CSA-E60079-15 for C-UL.
C-IT.ME62.B.04182 conforms to GOST R IEC 60079-0,GOST R IEC 60079-11, GOST R IEC 60079-15.
СЦ 16.0036 X conforms to ДСТУ 7113, ГОСТ 22782.5-78, ДСТУ IEC 60079-15.
TÜV Certificate No. C-IS-236198-04, SIL 2 conforms to IEC61508:2010 Ed. 2.
TÜV Certificate No. C-IS-236198-09, SIL 3 Functional Safety Certificate conforms to IEC61508:2010 Ed.2, for Management of Functional Safety.
Mounting:
T35 DIN-Rail according to EN50022, with or without Power Bus or on customized Termination Board.
Weight: about 125 g D5037D, 110 g D5037S.
Connection: by polarized plug-in disconnect screw terminal blocks to accommodate terminations up to 2.5 mm^2.
Location: installation in Safe Area or Zone 2, Group IIC T4.
Protection class: IP 20.
Dimensions: Width 12.5 mm, Depth 123 mm, Height 120 mm.

Ordering Information

Model:	D5037
1 channel	S
2 channels	D

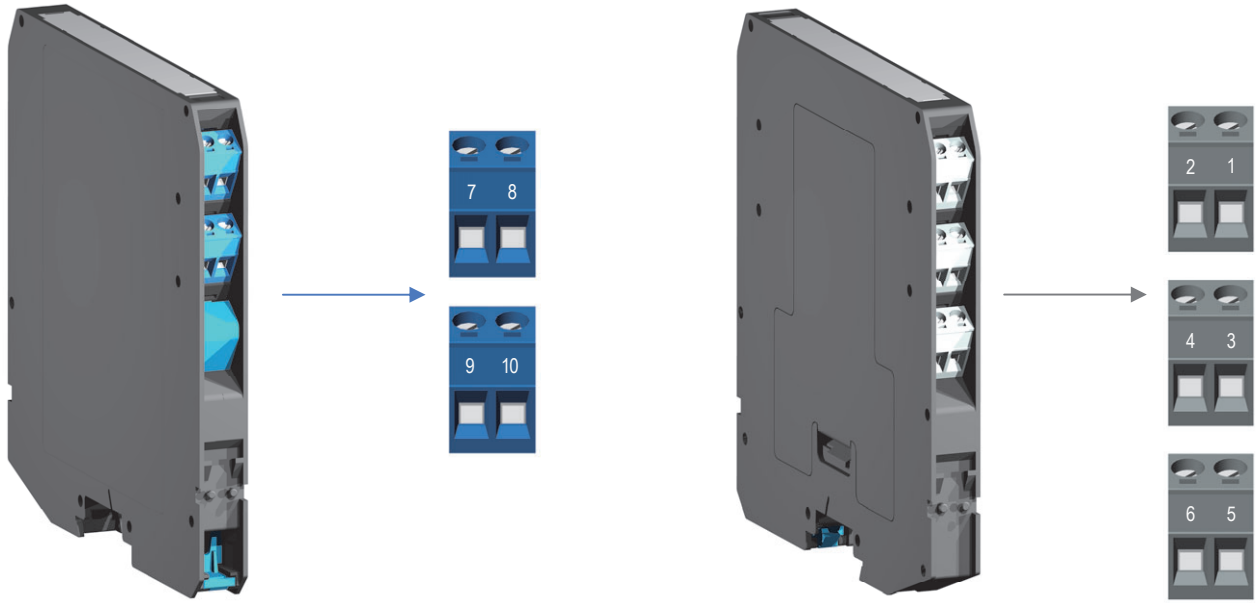
Power Bus and DIN-Rail accessories:
Connector JDFT049 Cover and fix MCHP196
Terminal block male MOR017 Terminal block female MOR022

Front Panel and Features



- SIL 2 according to IEC 61508:2010 Ed. 2
  for Tproof = 8 / 20 years (≤10% / >10 % of total SIF) for D5037S and D5037D.
- PFDavg (1 year) 1.21 E-04, SFF 77.15 % for D5037S.
- PFDavg (1 year) 1.21 E-04, SFF 78.15 % for D5037D.
- Systematic capability SIL 3
- Input from Zone 0 (Zone 20), installation in Zone 2
- NO/NC switch/proximity Detector Input, NO/NC transistor driving mode.
- Field open and short circuit detection.
- Three port isolation, Input/Output/Supply.
- EMC Compatibility to EN61000-6-2, EN61000-6-4, EN61326-1, EN61326-3-1 for safety system.
- In-field programmability by DIP Switch.
- ATEX, IECEx, UL & C-UL, EAC-EX, UKR TR n. 898, TÜV Certifications.
- TÜV Functional Safety Certification.
- High Density, two channels per unit.
- Simplified installation using standard DIN-Rail and plug-in terminal blocks, with or without Power Bus, or customized Termination Boards.
- 250 Vrms (Um) max. voltage allowed to the instruments associated with the barrier.

Terminal block connections



HAZARDOUS AREA	
7	+ Input Ch 1 for Proximity or Voltage free Contact
8	- Input Ch 1 for Proximity or Voltage free Contact
9	+ Input Ch 2 for Proximity or Voltage free Contact
10	- Input Ch 2 for Proximity or Voltage free Contact

SAFE AREA	
1	+ Output Ch 1
2	- Output Ch 1
3	+ Output Ch 2
4	- Output Ch 2
5	+ Power Supply 24 Vdc
6	- Power Supply 24 Vdc

Parameters Table

In the system safety analysis, always check the Hazardous Area/Hazardous Locations devices to conform with the related system documentation, if the device is Intrinsically Safe check its suitability for the Hazardous Area/Hazardous Locations and group encountered and that its maximum allowable voltage, current, power (Ui/Vmax, Ii/Imax, Pi/Pi) are not exceeded by the safety parameters (Uo/Voc, Io/Isc, Po/Po) of the D5037 series Associated Apparatus connected to it. Also consider the maximum operating temperature of the field device, check that added connecting cable and field device capacitance and inductance do not exceed the limits (Co/Ca, Lo/La, Lo/Ro) given in the Associated Apparatus parameters for the effective group. See parameters indicated in the table below:

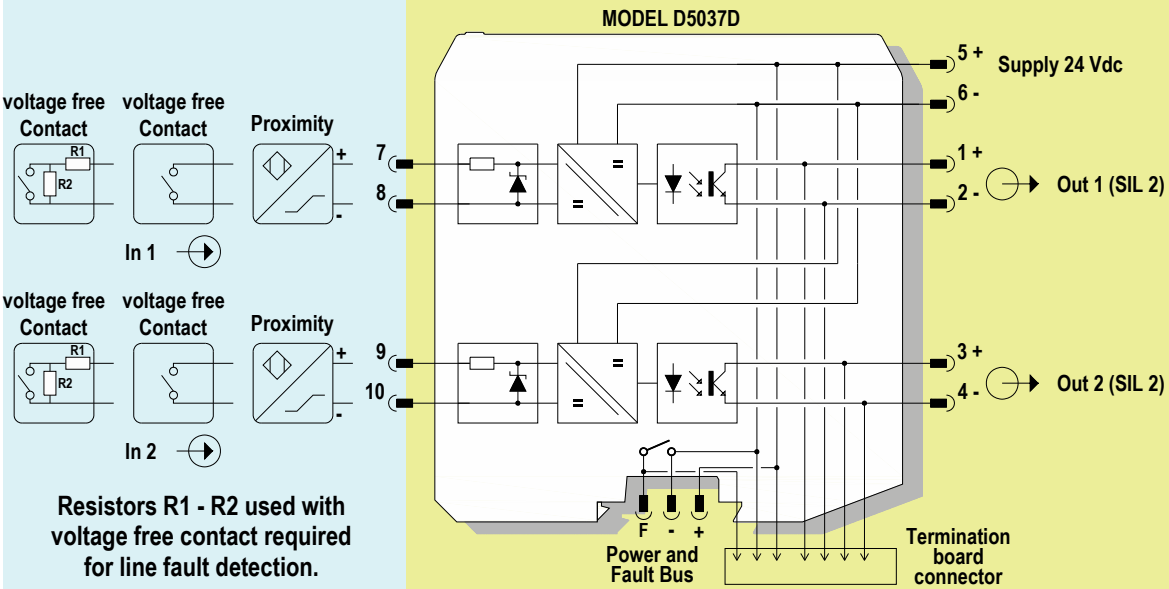
D5037 Terminals		D5037 Associated Apparatus Parameters		Must be	Hazardous Area/ Hazardous Locations Device Parameters
Ch1 Ch2	7 - 8 9 - 10	Uo / Voc = 10.5 V		≤	Ui / Vmax
Ch1 Ch2	7 - 8 9 - 10	Io / Isc = 22 mA		≤	Ii/ Imax
Ch1 Ch2	7 - 8 9 - 10	Po / Po = 56 mW		≤	Pi / Pi
D5037 Terminals		**D5037 Associated Apparatus Parameters Cenelec (US)**		**Must be**	**Hazardous Area/ Hazardous Locations Device + Cable Parameters**
Ch1 Ch2	7 - 8 9 - 10	Co / Ca = 2.41 µF Co / Ca = 16.8 µF Co / Ca = 75 µF Co / Ca = 66 µF Co / Ca = 16.8 µF	IIC (A, B) IIB (C) IIA (D) I IIIC (E, F, G)	≥	Ci / Ci device + C cable
Ch1 Ch2	7 - 8 9 - 10	Lo / La = 78.3 mH Lo / La = 313.4 mH Lo / La = 626.9 mH Lo / La = 1028.6 mH Lo / La = 313.4 mH	IIC (A, B) IIB (C) IIA (D) I IIIC (E, F, G)	≥	Li / Li device + L cable
Ch1 Ch2	7 - 8 9 - 10	Lo / Ro = 635µH/Ω Lo / Ro = 2543 µH/Ω Lo / Ro = 5087 µH/Ω Lo / Ro = 8347 µH/Ω Lo / Ro = 2543 µH/Ω	IIC (A, B) IIB (C) IIA (D) I IIIC (E, F, G)	≥	Li / Ri device and L cable / R cable

For installations in which both the Ci and Li of the Intrinsically Safe apparatus exceed 1 % of the Co and Lo parameters of the Associated Apparatus (excluding the cable), then 50 % of Co and Lo parameters are applicable and shall not be exceeded (50 % of the Co and Lo become the limits which must include the cable such that Ci device + C cable ≤ 50 % of Co and Li device + L cable ≤ 50 % of Lo).
If the cable parameters are unknown, the following value may be used: Capacitance 180pF per meter (60pF per foot), Inductance 0.60µH per meter (0.20µH per foot).

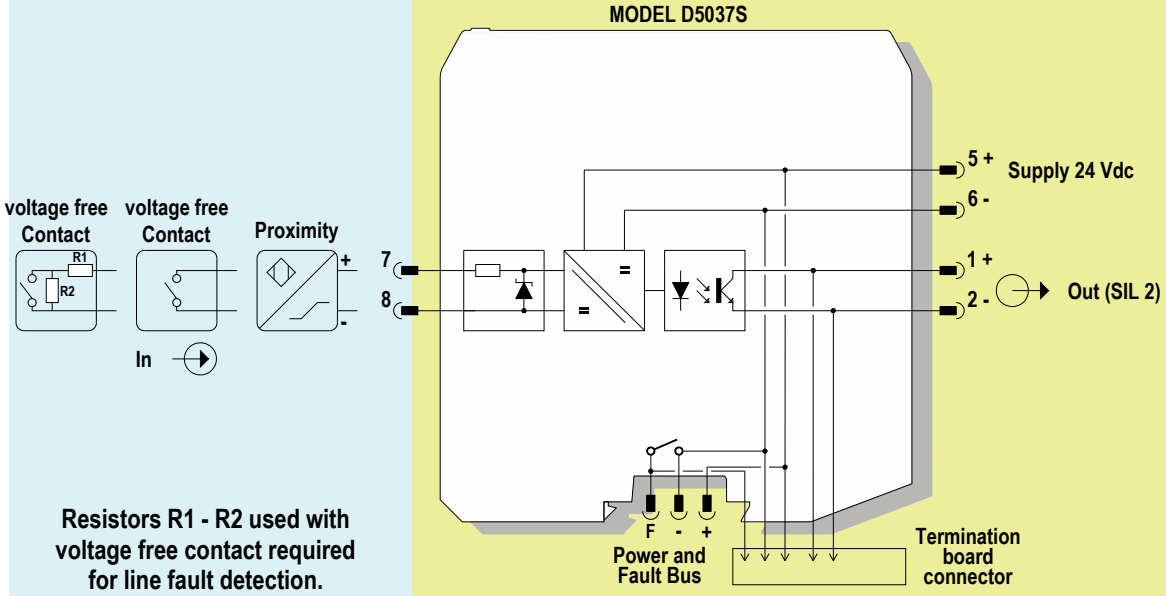
Function Diagram

HAZARDOUS AREA ZONE 0 (ZONE 20) GROUP IIC

SAFE AREA, ZONE 2 GROUP IIC T4

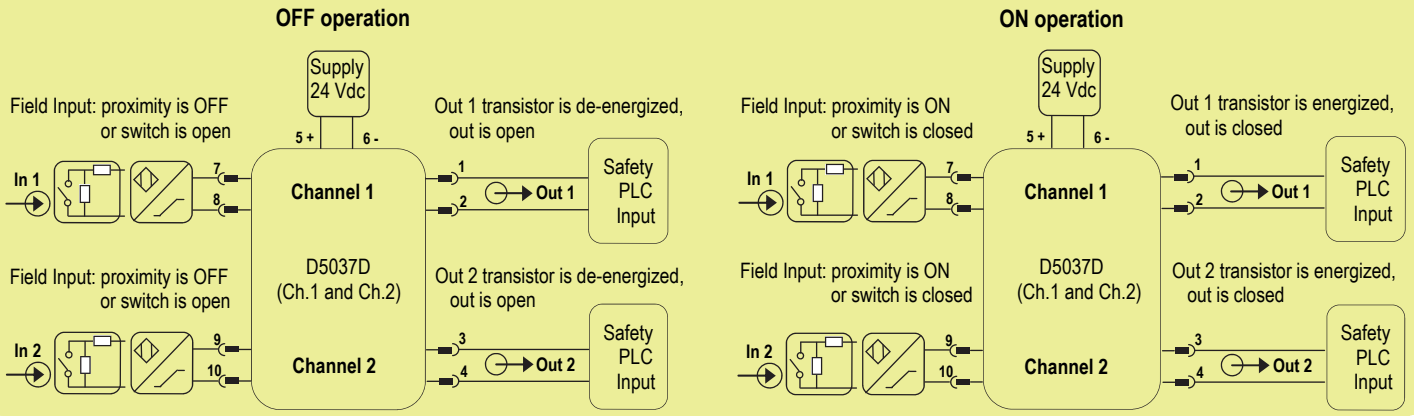


Resistors R1 - R2 used with voltage free contact required for line fault detection.



Resistors R1 - R2 used with voltage free contact required for line fault detection.

Application for D5037D



Description:

For this application, enable input line fault (open or short) detection and direct input to output transfer function, by set the internal dip-switches in the following mode (see page 9 for more information):

Dip-switch position	1	2	3	4
ON/OFF state	ON	OFF	ON	OFF

The module is powered by connecting 24 Vdc power supply to Pins 5 (+ positive) - 6 (- negative). The green LED is lit in presence of supply power.
Input signals from field are applied to Pins 7-8 (In 1 - Ch.1) and Pins 9-10 (In 2 - Ch.2).
Transistor outputs Pins 1-2 (for Channel 1) and Pins 3-4 (for Channel 2) are both normally open (or transistor de-energized as safe state condition) for OFF operation, while they are both closed (or transistor energized) for ON operation.
The following table describes for each channel the state (open or closed) of its output when its input signal is in OFF or ON state, and it gives information about turn-on or turn-off of the related channel status LED and channel fault LED:

Input signal state Pins 7-8 (In 1 - Ch.1) or 9-10 (In 2 - Ch.2)	Transistor output state Pins 1-2 (Out 1 - Ch.1) or 3-4 (Out 2 - Ch.2)	Channel status yellow LED state	Channel fault red LED state
Proximity sensor is OFF or switch is open	Open (De-energize transistor)	OFF	OFF
Proximity sensor is ON or switch is closed	Closed (Energized transistor)	ON	OFF
Independently from proximity sensor or switch state, the input line is break	Open (De-energized transistor as safe state condition)	OFF	ON
Independently from proximity sensor or switch state, the input line is in short circuit	Open (De-energized transistor as safe state condition)	OFF	ON

Safety Function and Failure behavior:

D5037D is considered to be operating in Low Demand mode, as a Type A module, having Hardware Fault Tolerance (HFT) = 0.
The failure behavior is described from the following definitions :

- □ Fail-Safe State: it is defined as the transistor output being open;
- □ Fail Safe: failure mode that causes the module / (sub)system to go to the defined Fail-Safe state without a demand from the process;
- □ Fail Dangerous: failure mode that does not respond to a demand from the process (i.e. being unable to go to the defined Fail-Safe state), so that the transistor output remains closed;
- □ Fail "No Effect": failure mode of a component that plays a part in implementing the Safety Function but that is neither a safe failure nor a dangerous failure. When calculating the SFF, this failure mode is not taken into account;
- □ Fail "Not part": failure mode of a component that is not part of the Safety Function but that is part of the circuit diagram and is listed for completeness. When calculating the SFF, this failure mode is not taken into account.

The 2 channels of D5037D module must not be used to increase the hardware fault tolerance, needed for a higher SIL of a certain Safety Function, as they are not completely independent each other, containing common components.
Failure rate date: taken from Siemens Standard SN29500.

Failure rate table:

Failure category	Failure rates (FIT)
λ_{dd} = Total Dangerous Detected failures	0.00
λ_{du} = Total Dangerous Undetected failures	27.48
λ_{sd} = Total Safe Detected failures	0.00
λ_{su} = Total Safe Undetected failures	98.30
$\lambda_{tot\ safe}$ = Total Failure Rate (Safety Function) = $\lambda_{dd} + \lambda_{du} + \lambda_{sd} + \lambda_{su}$	**125.78**
MTBF (safety function, channel 1) = (1 / $\lambda_{tot\ safe}$) + MTTR (8 hours)	**907 years**
$\lambda_{no\ effect}$ = "No Effect" failures	142.42
$\lambda_{not\ part}$ = "Not Part" failures	148.40
$\lambda_{tot\ device}$ = Total Failure Rate (Device) = $\lambda_{tot\ safe} + \lambda_{no\ effect} + \lambda_{not\ part}$	**416.60**
MTBF (device, channel 1) = (1 / $\lambda_{tot\ device}$) + MTTR (8 hours)	**274 years**

Failure rates table according to IEC 61508:2010 Ed.2 :

λ_{sd}	λ_{su}	λ_{dd}	λ_{du}	SFF
0.00 FIT	98.30 FIT	0.00 FIT	27.48 FIT	78.15%

PFDavg vs T[Proof] table (assuming Proof Test coverage of 99%), with determination of SIL supposing module contributes ≤10% of total SIF dangerous failures:

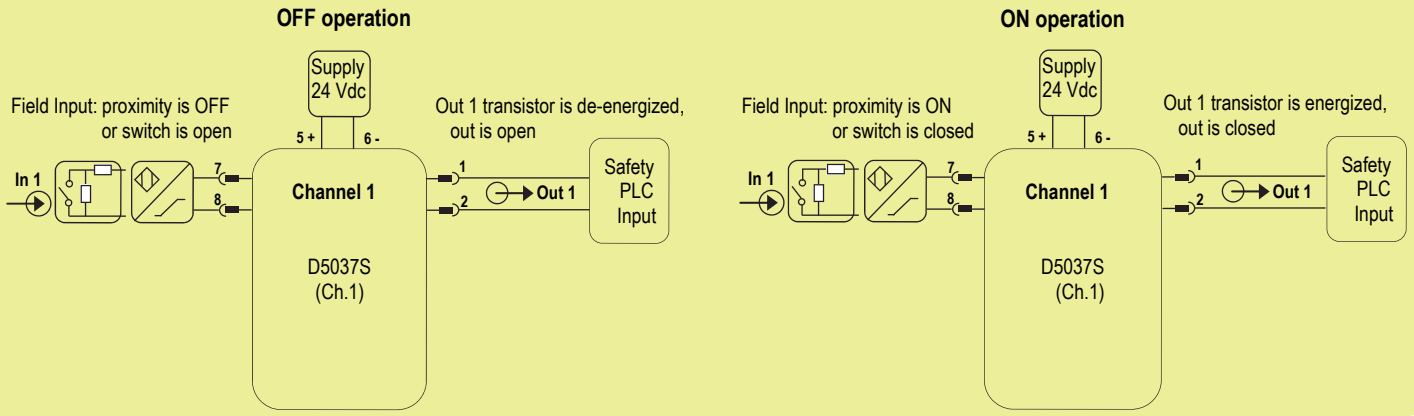
T[Proof] = 1 year	T[Proof] = 8 years
PFDavg = 1.21 E-04 Valid for **SIL 2**	PFDavg = 9.65 E-04 Valid for **SIL 2**

PFDavg vs T[Proof] table (assuming Proof Test coverage of 99%), with determination of SIL supposing module contributes >10% of total SIF dangerous failures:

T[Proof] = 20 years
PFDavg = 2.41E-03 Valid for **SIL 2**

Systematic capability SIL 3.

Application for D5037S



Description:

For this application, enable input line fault (open or short) detection and direct input to output transfer function, by set the internal dip-switches in the following mode (see page 10 for more information):

Dip-switch position	1	2	3	4
ON/OFF state	ON	OFF	Not used	Not used

The module is powered by connecting 24 Vdc power supply to Pins 5 (+ positive) - 6 (- negative). The green LED is lit in presence of supply power.
Input signal from field is applied to Pins 7-8 (In 1 - Ch.1).
Transistor output Pins 1-2 (for Channel 1) is normally open (or transistor de-energized as safe state condition) for OFF operation, while it is closed (or transistor energized) for ON operation.
The following table describes for Channel 1 the state (open or closed) of its output when its input signal is in OFF or ON state, and it gives information about turn-on or turn-off of its channel status LED and channel fault LED:

Input 1 signal state Pins 7-8 (In 1 - Ch.1)	Transistor Out 1 state Pins 1-2 (Out 1 - Ch.1)	Channel 1 status yellow LED state	Channel 1 fault red LED state
Proximity sensor is OFF or switch is open	Open (De-energize transistor)	OFF	OFF
Proximity sensor is ON or switch is closed	Closed (Energized transistor)	ON	OFF
Independently from proximity sensor or switch state, the input line is break	Open (De-energized transistor as safe state condition)	OFF	ON
Independently from proximity sensor or switch state, the input line is in short circuit	Open (De-energized transistor as safe state condition)	OFF	ON

Safety Function and Failure behavior:

D5037S is considered to be operating in Low Demand mode, as a Type A module, having Hardware Fault Tolerance (HFT) = 0.
The failure behavior is described from the following definitions :

- □ Fail-Safe State: it is defined as the transistor output being open;
- □ Fail Safe: failure mode that causes the module / (sub)system to go to the defined Fail-Safe state without a demand from the process;
- □ Fail Dangerous: failure mode that does not respond to a demand from the process (i.e. being unable to go to the defined Fail-Safe state), so that the transistor output remains closed;
- □ Fail "No Effect": failure mode of a component that plays a part in implementing the Safety Function but that is neither a safe failure nor a dangerous failure. When calculating the SFF, this failure mode is not taken into account;
- □ Fail "Not part": failure mode of a component that is not part of the Safety Function but that is part of the circuit diagram and is listed for completeness. When calculating the SFF, this failure mode is not taken into account.

Failure rate date: taken from Siemens Standard SN29500.

Failure rate table:

Failure category	Failure rates (FIT)
λ_{dd} = Total Dangerous Detected failures	0.00
λ_{du} = Total Dangerous Undetected failures	27.48
λ_{sd} = Total Safe Detected failures	0.00
λ_{su} = Total Safe Undetected failures	92.76
$\lambda_{tot\ safe}$ = Total Failure Rate (Safety Function) = $\lambda_{dd} + \lambda_{du} + \lambda_{sd} + \lambda_{su}$	**120.24**
MTBF (safety function, one channel) = (1 / $\lambda_{tot\ safe}$) + MTTR (8 hours)	**949 years**
$\lambda_{no\ effect}$ = "No Effect" failures	132.06
$\lambda_{not\ part}$ = "Not Part" failures	17.50
$\lambda_{tot\ device}$ = Total Failure Rate (Device) = $\lambda_{tot\ safe} + \lambda_{no\ effect} + \lambda_{not\ part}$	**269.80**
MTBF (device, one channel) = (1 / $\lambda_{tot\ device}$) + MTTR (8 hours)	**423 years**

Failure rates table according to IEC 61508:2010 Ed.2 :

λ_{sd}	λ_{su}	λ_{dd}	λ_{du}	SFF
0.00 FIT	92.76 FIT	0.00 FIT	27.48 FIT	77.15%

PFDavg vs T[Proof] table (assuming Proof Test coverage of 99%), with determination of SIL supposing module contributes ≤10% of total SIF dangerous failures:

T[Proof] = 1 year	T[Proof] = 8 years
PFDavg = 1.21 E-04 Valid for **SIL 2**	PFDavg = 9.65 E-04 Valid for **SIL 2**

PFDavg vs T[Proof] table (assuming Proof Test coverage of 99%), with determination of SIL supposing module contributes >10% of total SIF dangerous failures:

T[Proof] = 20 years
PFDavg = 2.41 E-03 Valid for **SIL 2**

Systematic capability SIL 3.

Testing procedure at T-proof

The proof test shall be performed to reveal dangerous faults which are undetected by diagnostic. This means that it is necessary to specify how dangerous undetected fault, which have been noted during the FMEDA, can be revealed during proof test.

Note for switch input: to detect a broken wire, or a short circuit condition, in the input connections it is necessary to mount, close to the switches, the end of line resistors: R1=1 KΩ typical (470 Ω to 2 KΩ range) resistor in series and R2=10 kΩ typical (5 KΩ to 15 KΩ range) resistor in parallel to the contacts.

The Proof test consists of the following steps:

Steps	Action
1	Bypass the Safety-related PLC or take any other appropriate action in order to avoid a false trip.
2	Vary the state conditions of the input sensors/contacts coming from field and verify that the transistor outputs change from de-energized to energized and vice versa; then, check that the de-energized state condition corresponds to the required Safety-related function.
3	If input line fault detection is enabled for each channel by means of a dip-switches specific set up, disconnect the input wiring coming from the field sensor/contact and check that the correspondent transistor output is de-energized. Then, put in short circuit condition the input connections and verify that the same output remains de-energized. In both cases, the related red alarm LEDs on the front panel will be turned on.
4	Restore the loop to full operation.
5	Remove the bypass from the safety-related PLC or restore normal operation.

This test will reveal approximately 99 % of possible Dangerous Undetected failures in the repeater.

Warning

D5037 series are isolated Intrinsically Safe Associated Apparatus installed into standard EN50022 T35 DIN-Rail located in Safe Area or Zone 2, Group IIC, Temperature T4, Hazardous Area (according to EN/IEC60079-15) within the specified operating temperature limits Tamb –40 to +70 °C, and connected to equipment with a maximum limit for AC power supply Um of 250 Vrms.
Not to be connected to control equipment that uses or generates more than 250 Vrms or Vdc with respect to earth ground.
D5037 series must be installed, operated and maintained only by qualified personnel, in accordance to the relevant national/international installation standards (e.g. IEC/EN60079-14 Electrical apparatus for explosive gas atmospheres - Part 14: Electrical installations in hazardous areas (other than mines)), following the established installation rules, particular care shall be given to segregation and clear identification of I.S. conductors from non I.S. ones.
De-energize power source (turn off power supply voltage) before plug or unplug the terminal blocks when installed in Hazardous Area or unless area is known to be nonhazardous.
Warning: substitution of components may impair Intrinsic Safety and suitability for Zone 2.
Explosion Hazard: to prevent ignition of flammable or combustible atmospheres, disconnect power before servicing or unless area is known to be nonhazardous.
Failure to properly installation or use of the equipment may risk to damage the unit or severe personal injury.
The unit cannot be repaired by the end user and must be returned to the manufacturer or his authorized representative.
Any unauthorized modification must be avoided.

Operation

D5037 module is a unit suitable for applications requiring SIL 2 level (according to IEC 61508) in safety related systems for high risk industries.
The unit can be configured for switch or proximity detector (EN60947-5-6, NAMUR), NO or NC and for NO or NC optocoupled open collector transistor output.
Each channel enables a Safe Area load to be controlled by a switch, or a proximity detector, located in Hazardous Area.
Fault detection circuit (DIP switch configurable) is available for both proximity sensor and switch equipped with end of line resistors. In case of fault, when enabled it de-energizes the corresponding output transistor and turns the fault LED on; when disabled the corresponding output transistor repeats the input line open or closed status as configured.
In case of fault output, transistor driving can be programmed as normally close or normally open.
Presence of supply power and status of output (energized or de-energized), as well as integrity or fault condition of sensor and connecting line are displayed by signaling LEDs (green for power, yellow for status and red for fault condition).

Note: use of voltage free electrical contacts with fault detection enabled (control equipment) requires, near the switch at the end of the line a R1=1 kΩ typical (470 Ω to 2 kΩ range) resistor in series and a R2=10 kΩ typical (5 kΩ to 15 kΩ range) resistor in parallel to the contacts in order to allow the fault detection circuit to distinguish between a condition of contact close/open and a line open/short circuit fault.

Installation

D5037 series are Switch/Proximity Detector Interface housed in a plastic enclosure suitable for installation on T35 DIN-Rail according to EN50022, with or without Power Bus or on customized Termination Board.
D5037 unit can be mounted with any orientation over the entire ambient temperature range.
Electrical connection of conductors up to 2.5 mm² are accommodated by polarized plug-in removable screw terminal blocks which can be plugged in/out into a powered unit without suffering or causing any damage **(for Zone 2 installations check the area to be nonhazardous before servicing)**.
The wiring cables have to be proportionate in base to the current and the length of the cable.
On the section “Function Diagram” and enclosure side a block diagram identifies all connections.
Identify the number of channels of the specific card (e.g. D5037S is a single channel model and D5037D is a dual channel model), the function and location of each connection terminal using the wiring diagram on the corresponding section, as an example:
Connect 24 Vdc power supply positive at terminal “5” and negative at terminal “6”.
For Model D5037S connect positive output of channel 1 at terminal “1” and negative output at “2”.
For Model D5037D in addition to channel 1 connections above, connect positive output of channel 2 at terminal “3” and negative output at “4”.
For Model D5037S, in case of Proximity or Voltage free Contact, connect the wires at terminal “7” for positive and “8” for negative.
For Model D5037D in addition to channel 1 connections above, connect terminal “9” for positive and “10” for negative on channel 2.

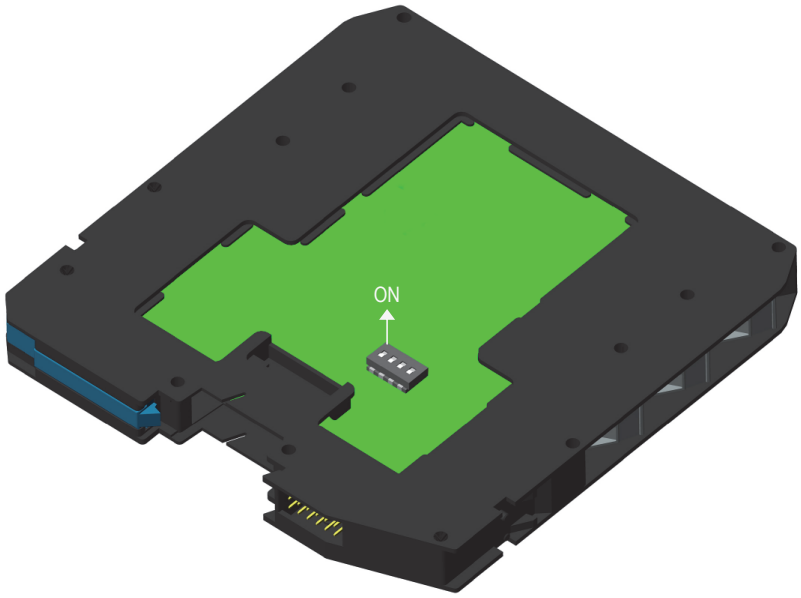
Intrinsically Safe conductors must be identified and segregated from non I.S. and wired in accordance to the relevant national/international installation standards (e.g. EN/IEC60079-14 Electrical apparatus for explosive gas atmospheres - Part 14: Electrical installations in hazardous areas (other than mines)), make sure that conductors are well isolated from each other and do not produce any unintentional connection.
Connect SPST output transistors checking the load rating to be within the maximum rating (100 mA at 35 Vdc (≤ 1.5 V voltage drop)).
The enclosure provides, according to EN60529, an IP20 minimum degree of mechanical protection (or similar to NEMA Standard 250 type 1) for indoor installation, outdoor installation requires an additional enclosure with higher degree of protection (i.e. IP54 to IP65 or NEMA type 12-13) consistent with the effective operating environment of the specific installation.
Units must be protected against dirt, dust, extreme mechanical (e.g. vibration, impact and shock) and thermal stress, and casual contacts.
If enclosure needs to be cleaned use only a cloth lightly moistened by a mixture of detergent in water.
Electrostatic Hazard: to avoid electrostatic hazard, the enclosure of D5037 must be cleaned only with a damp or antistatic cloth.
Any penetration of cleaning liquid must be avoided to prevent damage to the unit. Any unauthorized card modification must be avoided.
According to EN61010, D5037 series must be connected to SELV or SELV-E supplies.

Start-up

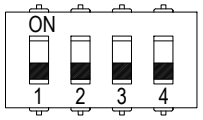
Before powering the unit check that all wires are properly connected, particularly supply conductors and their polarity, input and output wires, also check that Intrinsically Safe conductors and cable trays are segregated (no direct contacts with other non I.S. conductors) and identified either by color coding, preferably blue, or by marking. Check conductors for exposed wires that could touch each other causing dangerous unwanted shorts. Turn on power, the “power on” green led must be lit, status and fault led on each channel must be in accordance with condition of the corresponding input line. If possible close and open input lines one at time checking the corresponding status and fault leds condition as well as output to be correct.

D5037D

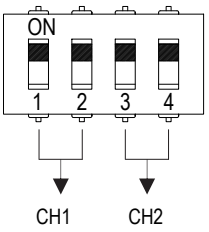
A configuration DIP switch is located on component side of pcb. This switch allows the configuration of input/output relationship, fault detection functions and operating mode.

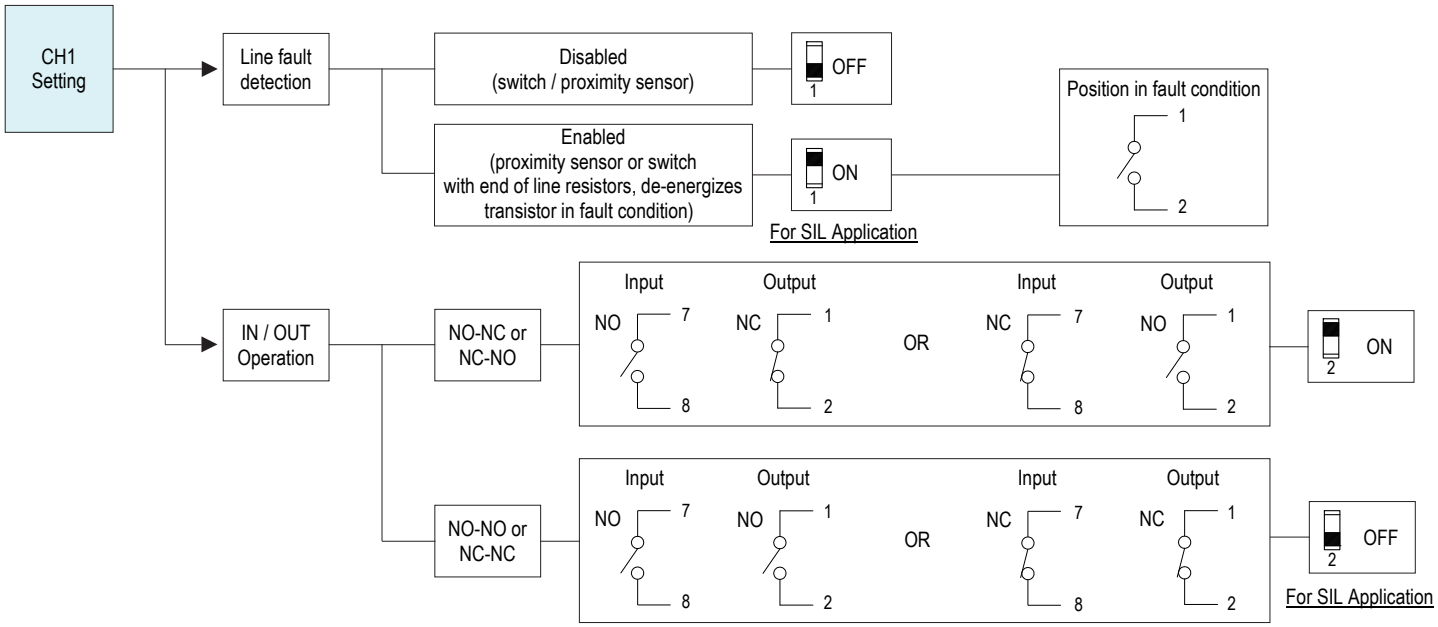


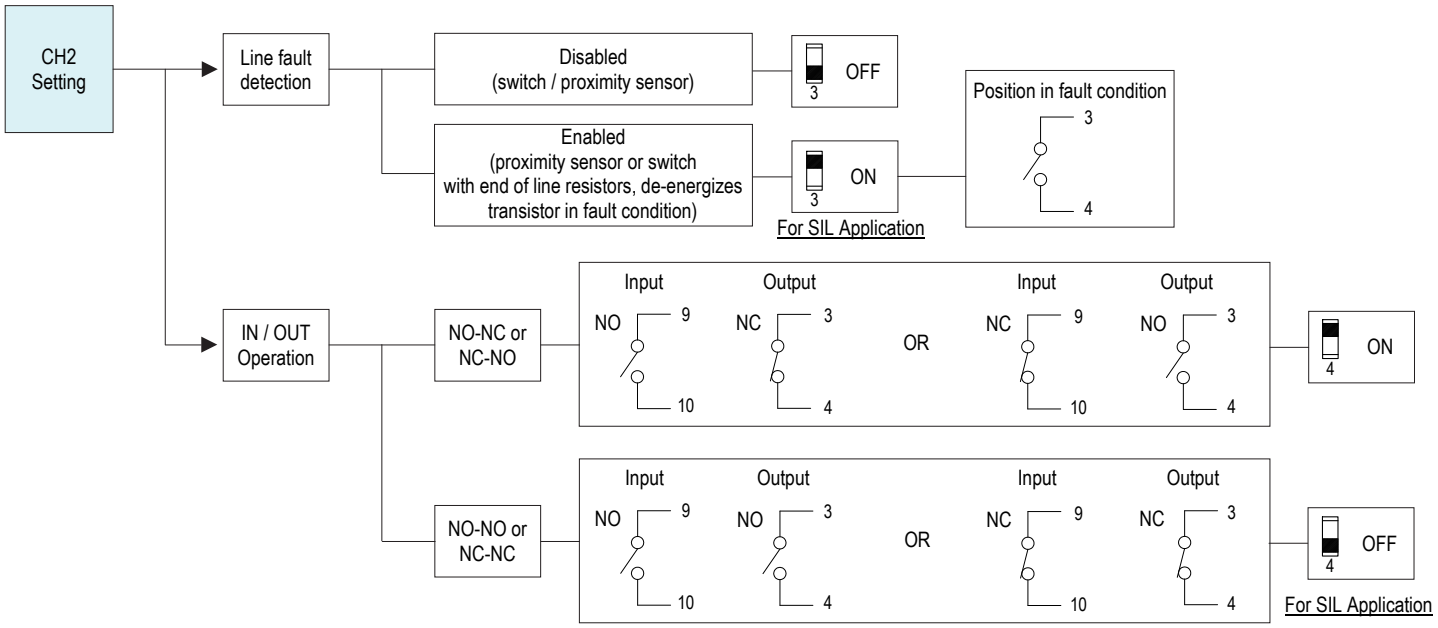
Dip switch factory settings. All Switches are OFF



Dip switch configuration

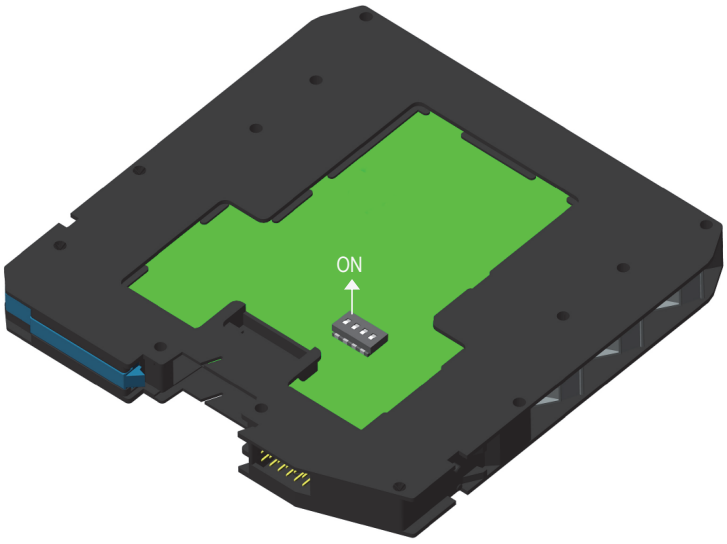




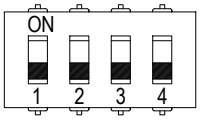


D5037S

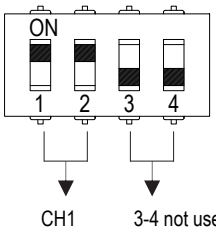
A configuration DIP switch is located on component side of pcb. This switch allows the configuration of input/output relationship, fault detection functions and operating mode.

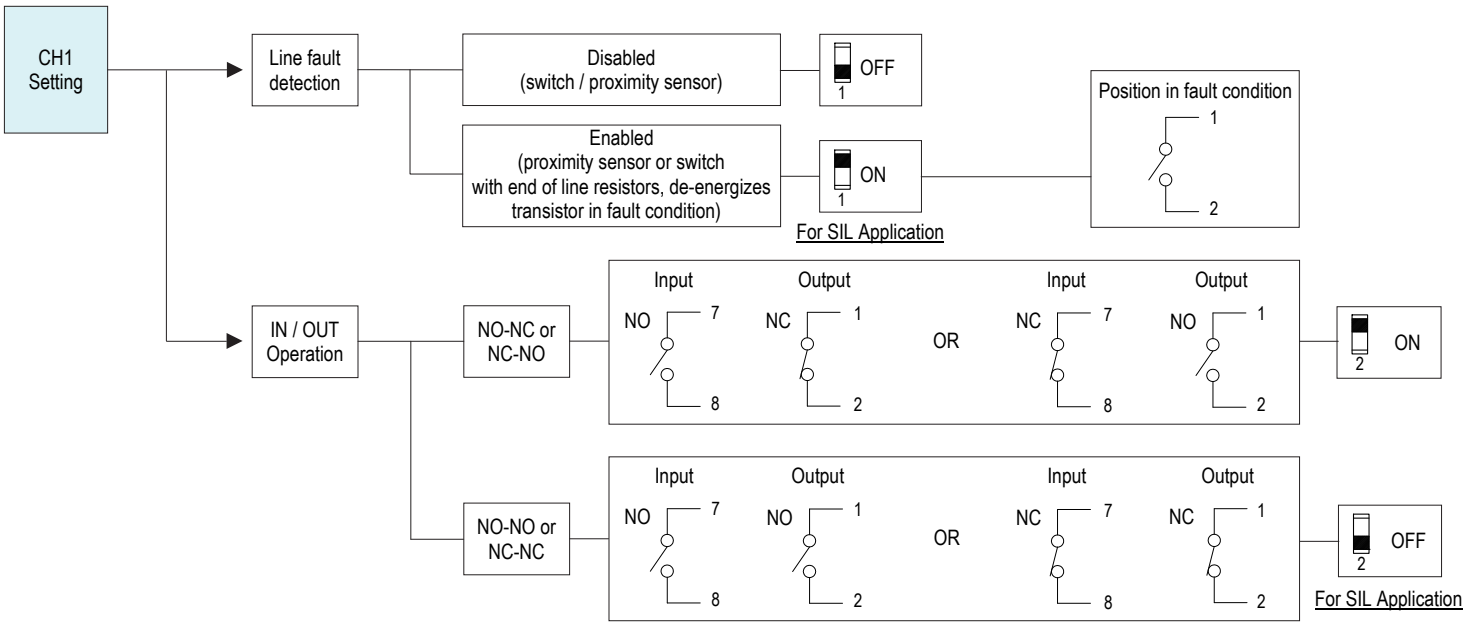


Dip switch factory settings. All Switches are OFF



Dip switch configuration





DIP Switch factory settings (valid for D5037S and D5037D)

SW1	SW2	SW3	SW4
OFF	OFF	OFF	OFF

Note: SW3 and SW4 used only in D5037D.

D5037D Configuration Summary Table

Channel	1	2
Line fault detection	SW1	SW3
Disabled (switch/proximity sensor)	OFF	OFF
Enabled, for SIL application (proximity sensor or switch with end of line resistors, detects field open circuit and short circuit, de-energizes transistor in fault condition)	ON	ON

Channel	1	2
IN/OUT Operation	SW2	SW4
NO-NC or NC-NO	ON	ON
NO-NO or NC-NC (for SIL application)	OFF	OFF

D5037S Configuration Summary Table

Line fault detection	SW1
Disabled (switch/proximity sensor)	OFF
Enabled, for SIL application (proximity sensor or switch with end of line resistors, detects field open circuit and short circuit, de-energizes transistor in fault condition)	ON

IN/OUT Operation	SW2
NO-NC or NC-NO	ON
NO-NO or NC-NC (for SIL application)	OFF

Note: SW3 and SW4 not used.